The VMM ASIC, from R&D to production

George lakovidis

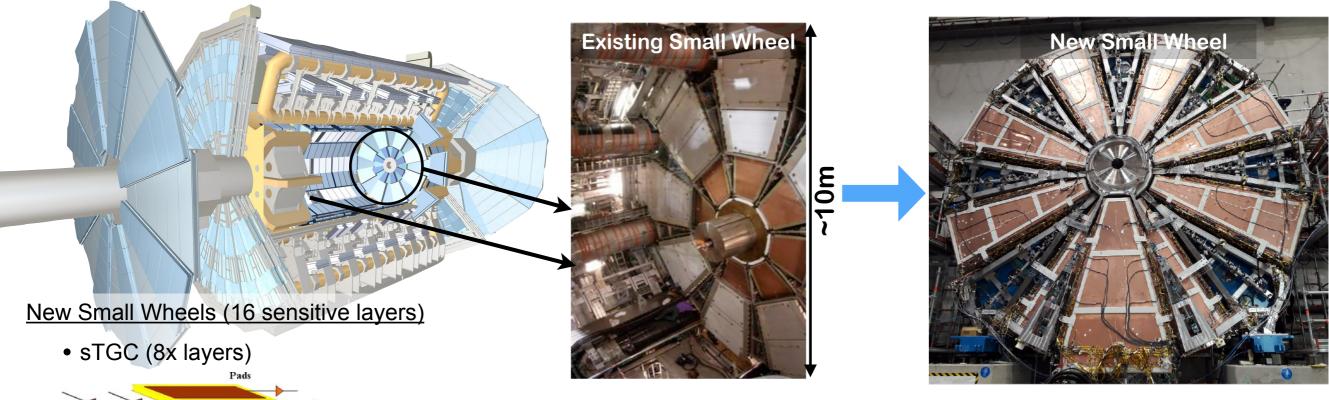




BROOKHAVEN SCIENCE ASSOCIATES

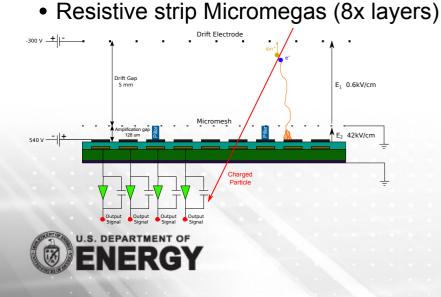
The ATLAS New Small Wheel(s) Upgrade

- The motivation for developing the VMM ASIC was the ATLAS NSW upgrade at CERN
- Biggest MPGD development and the most complex part of the ATLAS muon spectrometer ever built



Front-end Electronics Requirements (need of custom ASIC)

- Challenge of this Project <u>More than 2.4 million</u> channels total (2.1M for Micromegas and 300k for sTGC) (<u>full MS of ATLAS ~1.6M channels</u>)
- Operate with both charge polarities
- Sensing element capacitance 50-200pF (sTGC Pad up to 3nF)
- Charge measurements up to 2pC @ < 1fC RMS(6pC for sTGC pads)
- Time measurements ~ 100ns @ < 1ns RMS
- Multiple Trigger primitives, complex logic
- Digitisation, deep FIFOs, Low power, programmable
- Space requirements on the detector
- Radiation tolerant



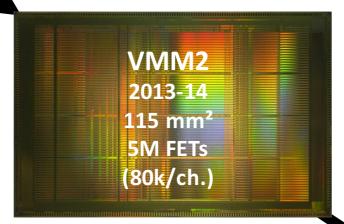


The VMM front-end ASIC - Evolution



- 2-phase readout with external ADC
- peak and timing information

- ☑ Three ADCs per channel



- ✓ Serialised ART with DDR
- Additional timing modes
- Additional functions and fixes

- ☑ LVL0 pipeline and buffering for ATLAS
- ☑ Revised front-end for high charge and capacitance (2nF, 50pC, fast recovery)
- ☑ Reset controls
- ☑ Timing ramp optimisation

- ✓ VMM3a fixed open bugs from VMM3 and introduce some stability fixes on the ADCs and Front-end

The VMM was designed at BNL in collaboration with IFIN-HH

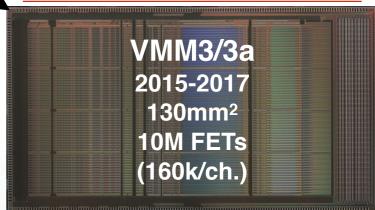
★ It is fabricated in the 130nm Global Foundries
8RF-DM process (former IBM 8RF-DM)



BGA 400, 1mm



VMM3a - Production Version!

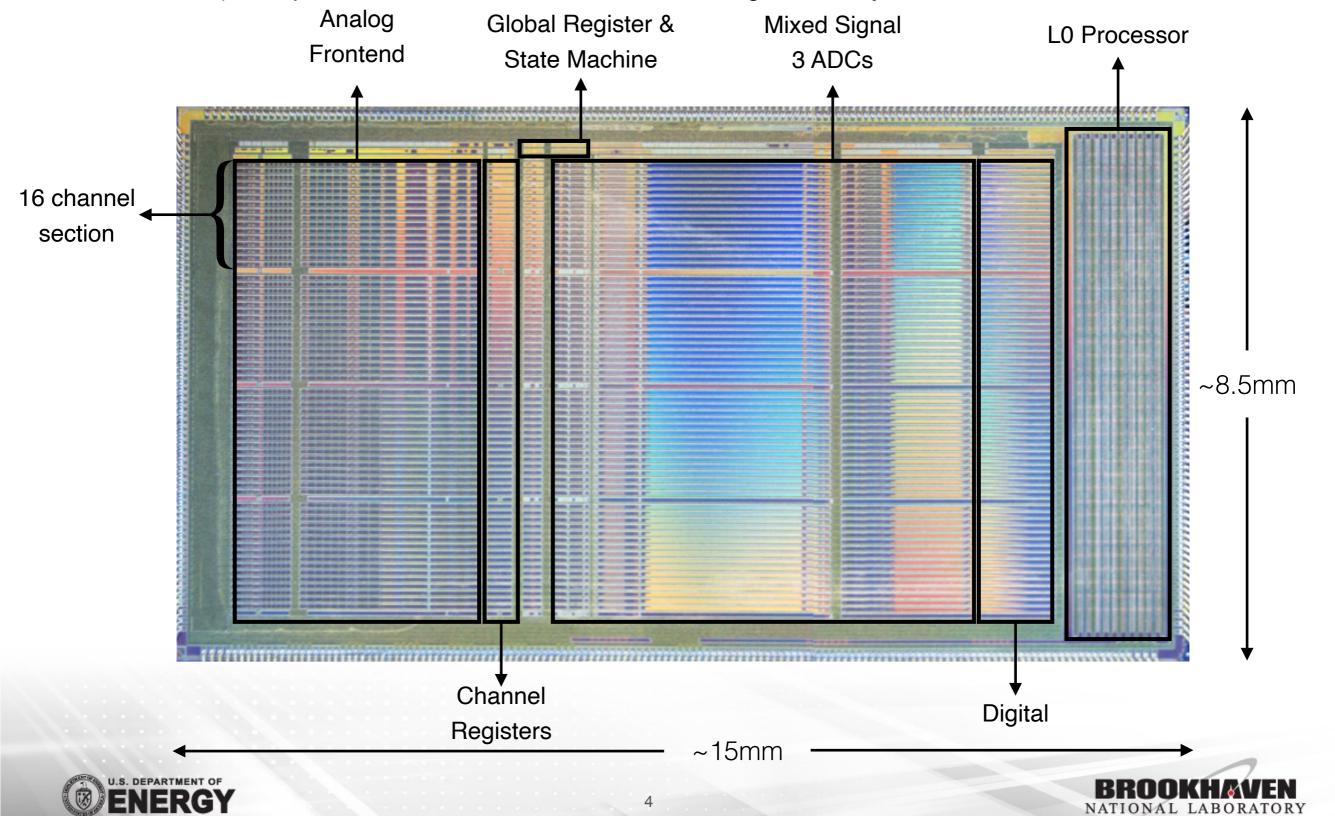


~10mW/channel

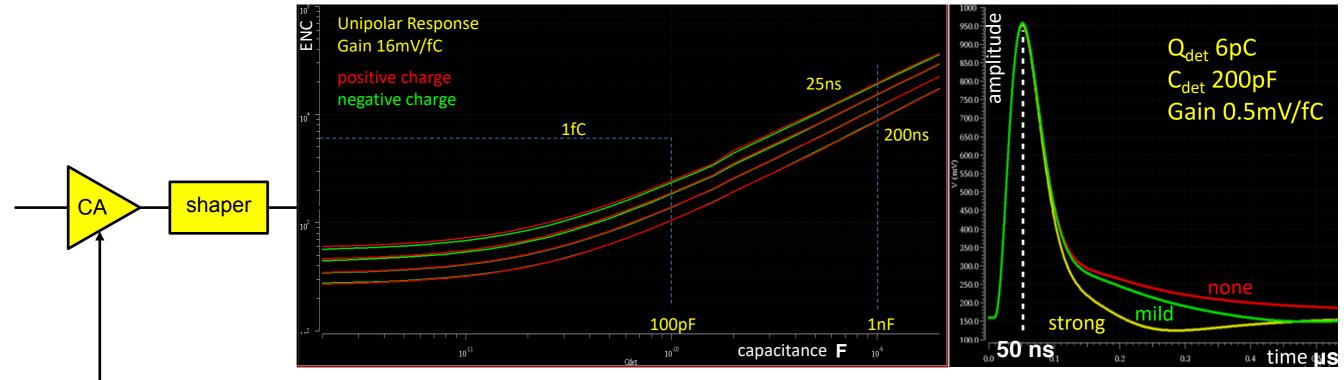


An actual photo of the ASIC

• The ASIC features **64 channels** that extend along the size of the die. At the end the L0 section (explained in later slides) is separated to isolate the noise from the digital activity

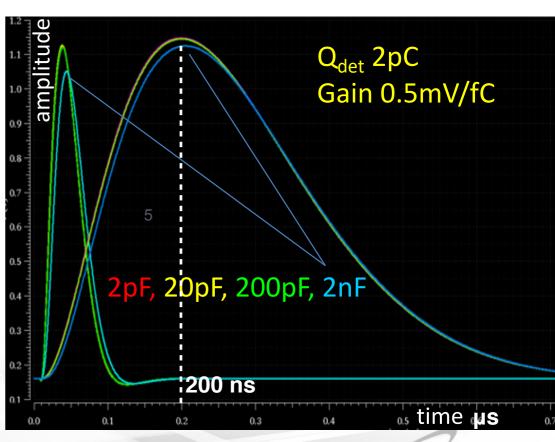


VMM3a Amplifier & Shaper

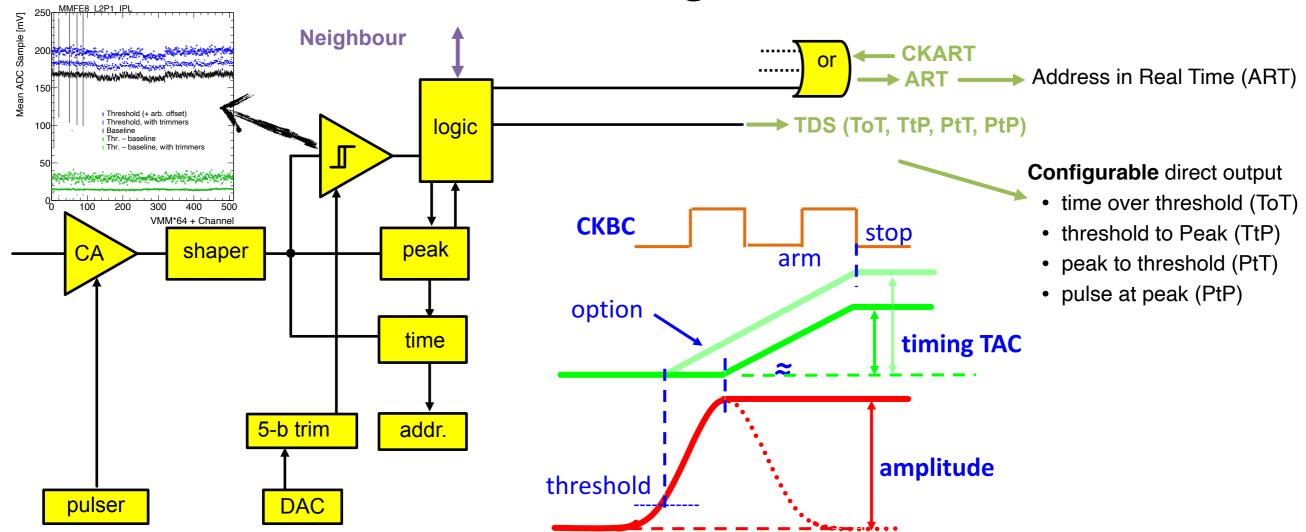


- Input transistor: PMOS, 3 stage amplifier,
 - 2 stages used for adjustable gain: 0.5, 1, 3, 4.5, 6, 9, 12,
 16 mV/fC
 - last stage for **charge inversion** (positive or negative)
- Input capacitance: can operate from sub-pF to several nF
- Maximum charge: 2 pC in linear range, fast recovery from 50 pC
- Semi gaussian DDF c-shaper 3rd order
 - Configurable ion tail suppression: none, mild or strong
 - Adjustable peaking time: 25, 50, 100, 200 ns
 - Leakage-adaptive, BGR-stabilised baseline





VMM3a Discrimination, Charge and Time

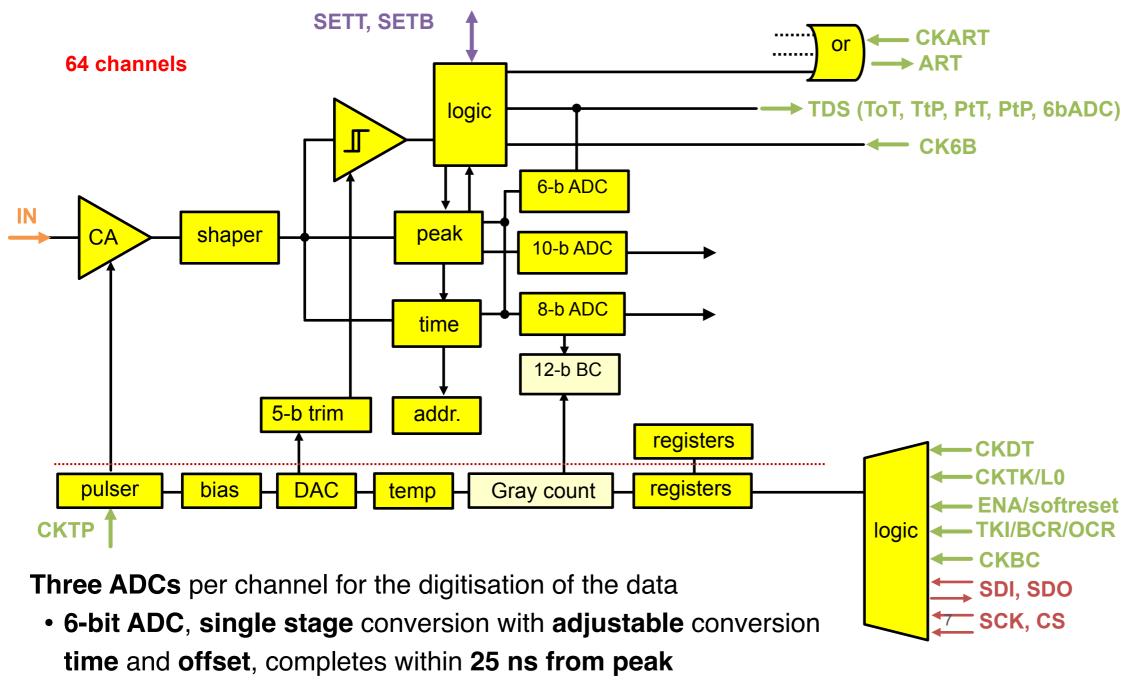


- Global 10-bit DAC for adjusting the **threshold Discrimination** with sub-hysterisis (effective 2mV)
- Adjustable 5-bit discrimination threshold per channel to adjust at ~mV level
- Neighbour logic to trigger sub-threshold channels with inter-chip communication
- Configurable direct output per channel and serial fast output of address as an OR of all channels
- Peak detection: measurement of peak amplitude and storage in analog memory
- Time detection: measurement of peak/threshold timing through a configurable time to amplitude converter (TAC: 60, 100, 350, 650 ns) and storage in analog memory
 - Clock working mode on synchronous machines but also as strobe for asynchronous operations





VMM3a ADCs

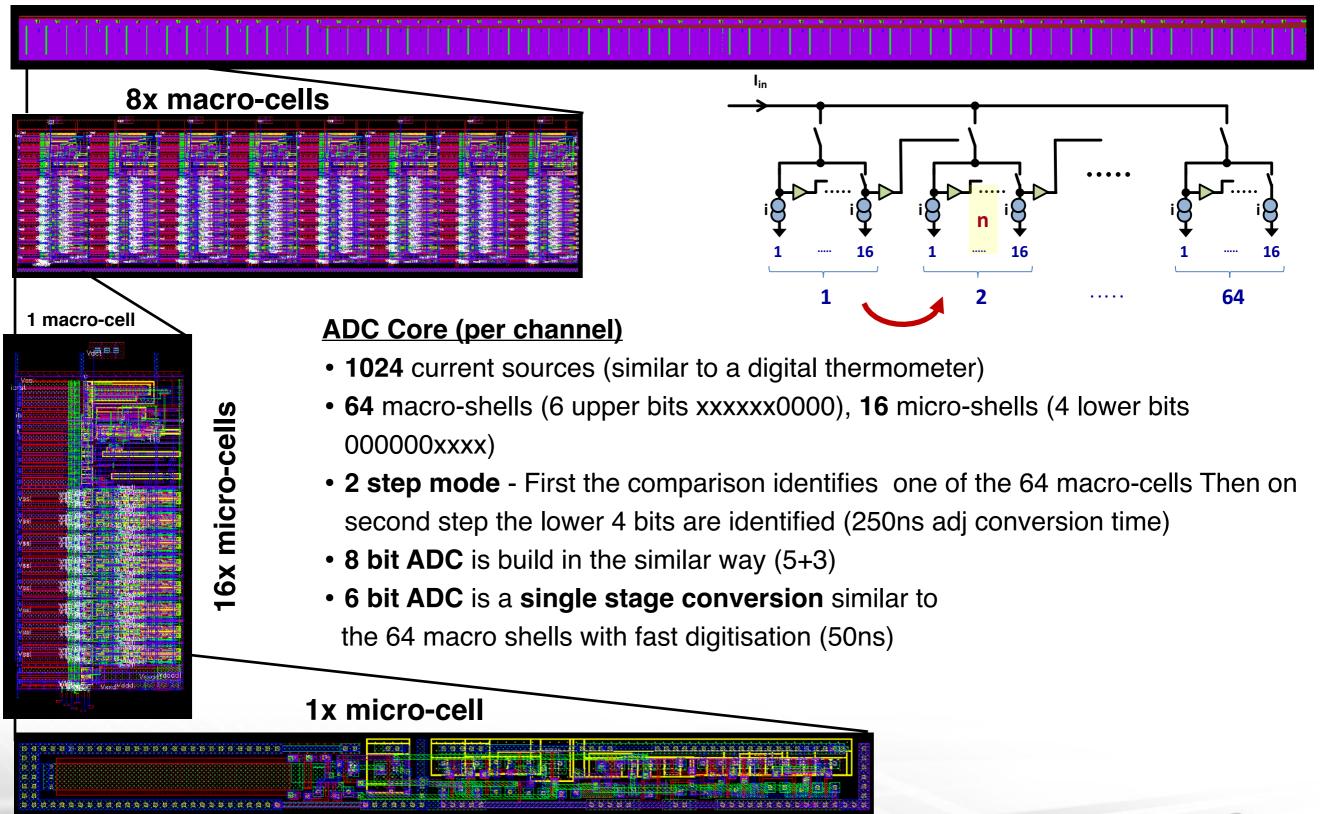


- 10-bit ADC, 200 ns adjustable conversion time/offset, for peak amplitude conversion
- 20-bit timing information with 8-bit ADC, 100 ns conversion time + 12-bit Gray-code counter, BC clock
- 2 step mode conversion for 10-bit & 8-bit ADCs First stage the comparison identifies one of the macro-cells and at the second stage the micro-cell is identified, possibility to jump through macro-cells





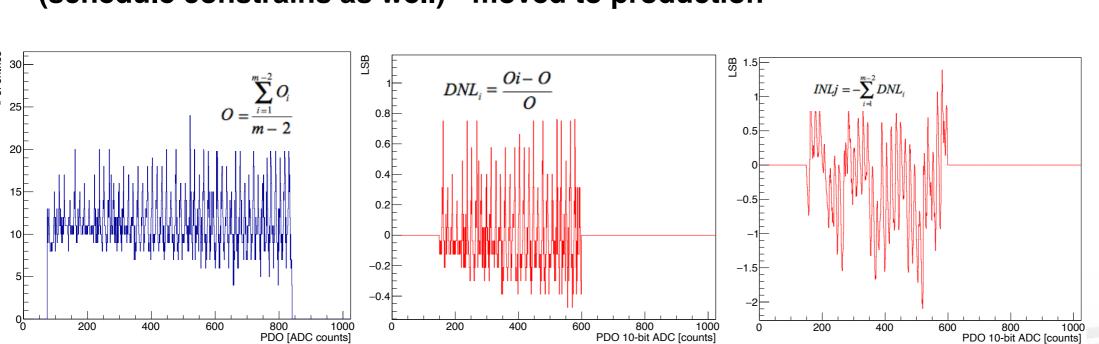
10-bit Current-Mode Domino ADC - Functionality ADC Cells

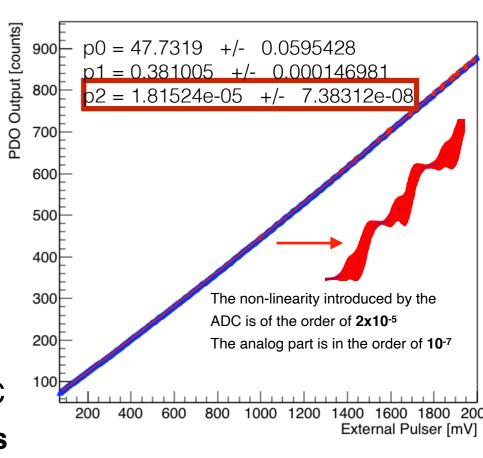




ADC Performance (eg 10-bit ADC)

- Even from the VMM2, the ADCs have been proven one of the most difficult points on VMM
- ADCs on VMM2 showed missing codes, high accumulation and degradation of performance
- Situation was significantly improved on VMM3a which addressed several problem but still not perfect
- Using DNL and INL is calculated and used to estimate the ENOB of the 10-bit ADC
- Equivalent number of bits ~7.5 (noise free) for the 10-bit ADC
- Performance was considered enough for gaseous detectors (schedule constrains as well) - moved to production

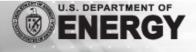




$$\sigma_c = \sqrt{\frac{1}{12} + \frac{1}{m-2} \sum_{i=1}^{m-2} INL_i^2}$$

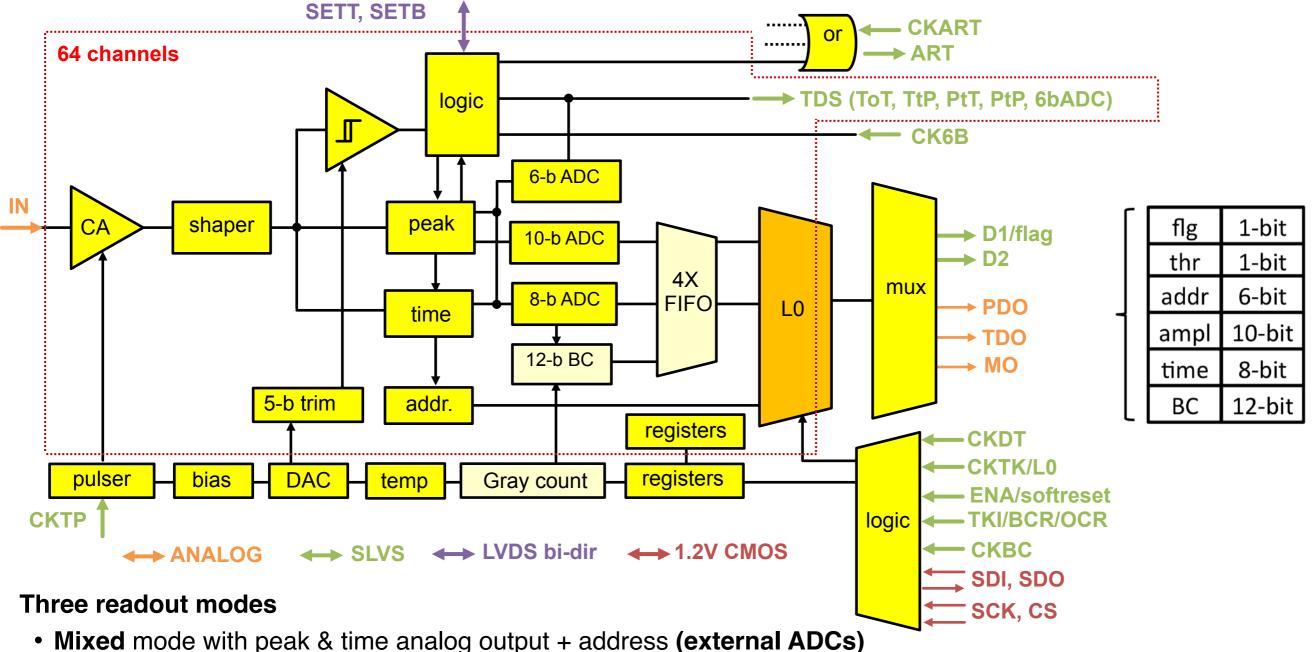
Then, ENOB can be calculated as

$$ENOB = \log_2 \frac{m}{\sigma_c \sqrt{12}}$$





VMM3a Readout & Overall **Architecture**



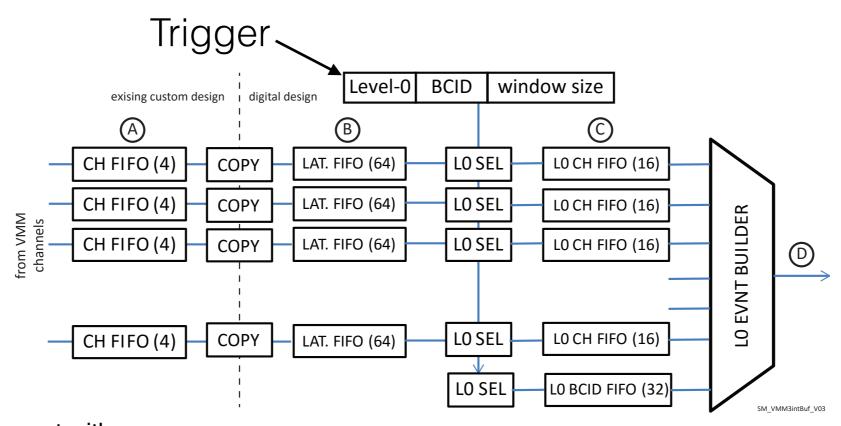
- Mixed mode with peak & time analog output + address (external ADCs)
- Digital continuous with internal ADCs and 38-bit data at 2 outputs with 200MHz DDR, triggerless or with external trigger and auto reset
- Level-0 processor external trigger mode with 64-deep latency FIFO programmable acceptance windows with 8b/10b encoding. Each channel could achieve 4MHz, total latency 16us





Modes of operation - ATLAS L0 readout

- Each channel has a Level-0 Selector circuit which is connected to the output of the channel's latency FIFO.
- The selector finds events within the BCID window (maximum size of 8 BC clocks) of a
 Level-0 Accept and copies them to the L0 Ch FIFO. The data are available in the output which
 is running on IDLE K28.5 in two data lines and can be readout DDR at a speed of 640Mbps
 (160MHz clock tested, effective bandwidth 560Mbps due to 8b/10b encoding).



 VMM will build the event with common BCID +relative for each hit

Header is sent out once no data found

	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30 31
header	٧	Р	0	rb	BCID				(12)					1st word after comma								mma									
hit data	1	Р	R	Т		Chan# (6)			ADC (10						0)				TDC (8)						N	rel	BCID				

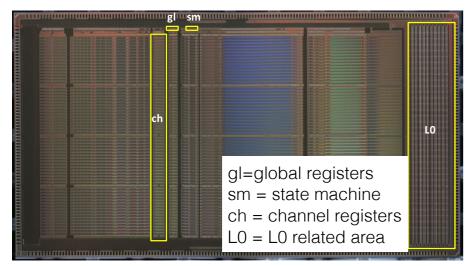
LL_format_VMM3out_V04



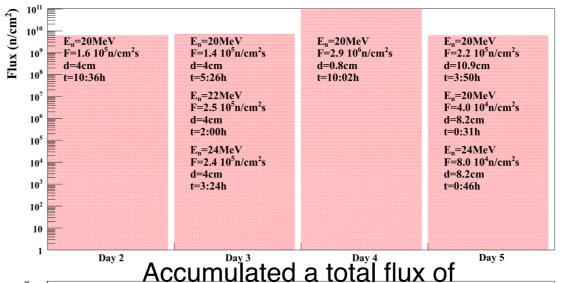


Single Event Upset & Total Ionisation Dose

- In the VMM3a there are three types of storage elements that require SEU protection, the configuration registers, the state machine control logic and the L0 logic
- To mitigate for SEU two techniques are used:
 - Dual Interlocked Cells (DICE) for the protection of the configuration registers
 - Triple Modular Redundancy (TMR) for the state machines and the L0 Logic blocks
- L0 Data
 - Single-bit faults on data are flagged by a parity bit
 - The parity is registered in the FIFOs and transmitted outside



Block	Method
BC counter	TMR
Latency FIFO CTRL	Parity on FIFO pointer, FIFO resets if parity err
LO FIFOs Control	TMR
Event Builder	TMR
LOA register/Nskip circuit	TMR L0 block protection



Accumulated a total flux of

~1.17x10¹¹n/cm² in 35.8h

Day 2 Day 3 Day 4 Day 5



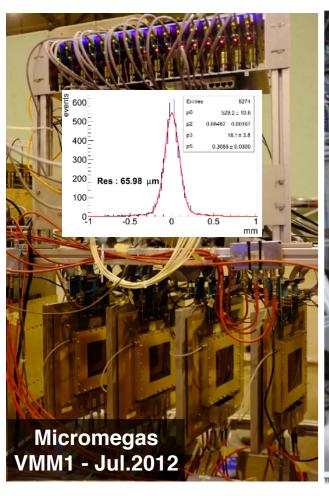
4 VMM3a were irradiated at the 60Co

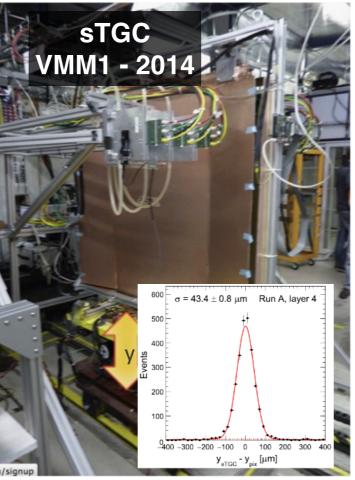


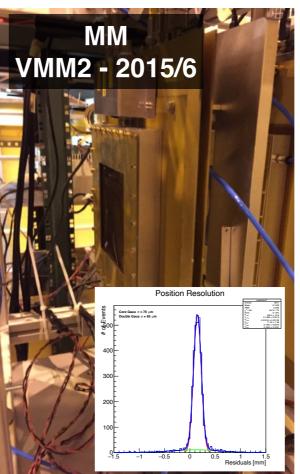


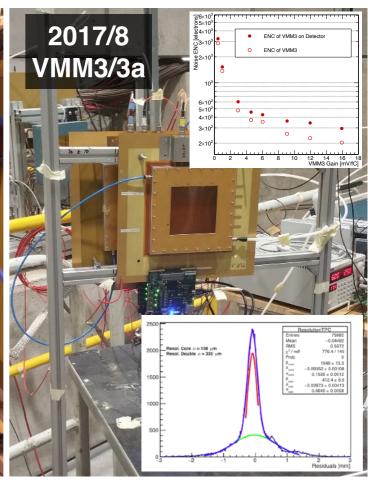


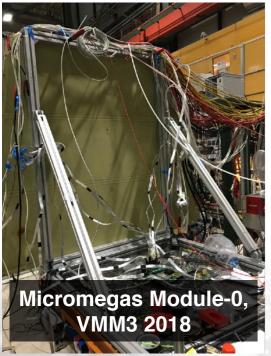
Test Beams from 2012 to 2018

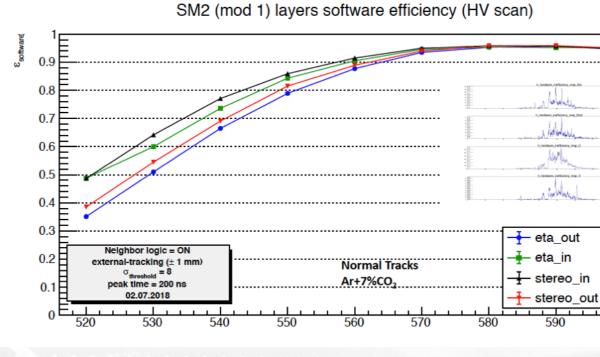


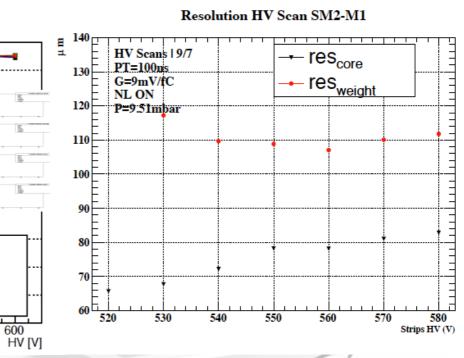








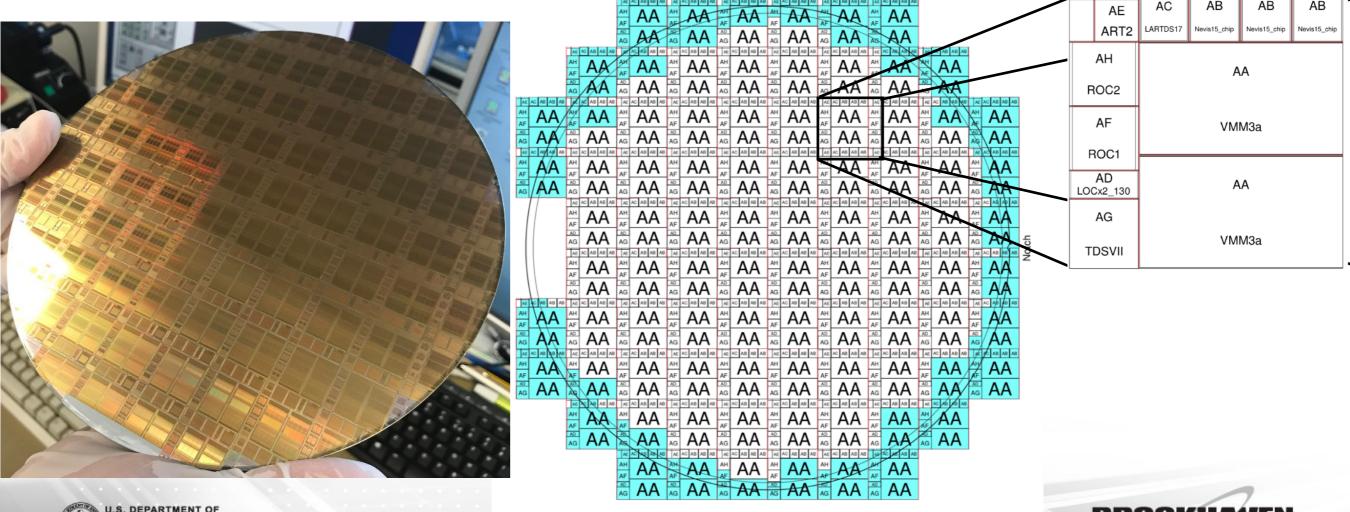






VMM Production

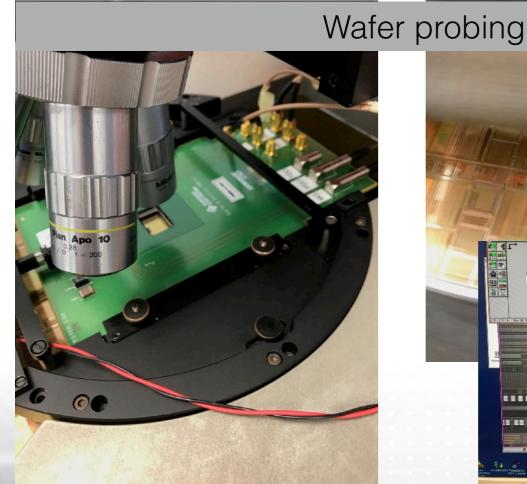
- The VMM is produced in a 8" wafer with 2 copies of the chip in a reticle, total 113 chips / wafer
- During the production we faced several issues due to GF processing affecting the yield
- Many iterations with experts from Global Foundries to improve the yield and understand the issue
- Investigation concluded (HPT process maintained throughout the production for high density metal layers)
- In ATLAS we had no time to further investigate the issue and moved forward to production
- ATLAS has already produced and package <u>73k</u> VMMs (incl. prototyping)
- Many other experiments and applications submitted proposals to use it (already in use by others)

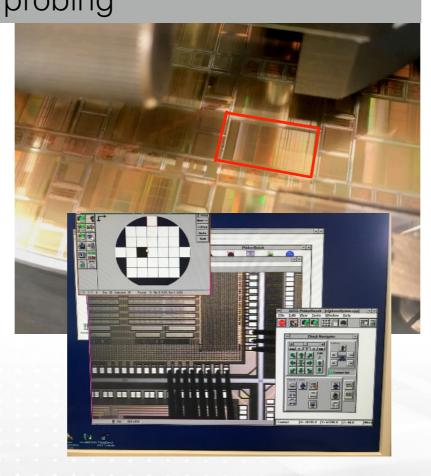


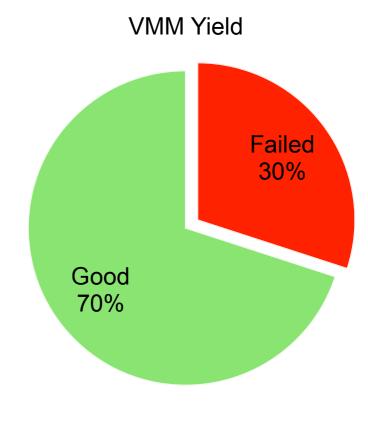


VMM Production testing

- Many testing protocols have been produced for testing the devices
- Direct wafer probing was developed to allow initial screening of the production batch (no detailed testing, only the frontend)
- Half of the production was tested by manual operators (lengthy process)
- Due to constrains in time, we developed automated testing (30sec/ device) which accelerated dramatically the process
- Throughout the process, 70% yield was achieved, 30% mainly due to ESD damage on input transistor or baseline stabilising circuit





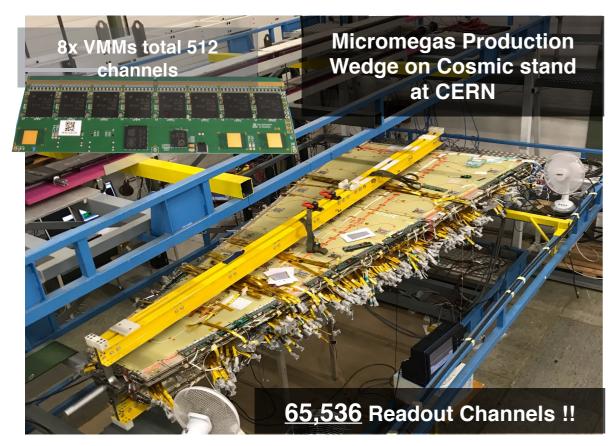


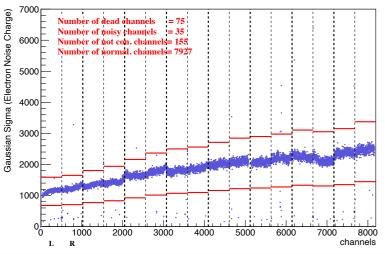




Integration with Micromegas & sTGC Production modules

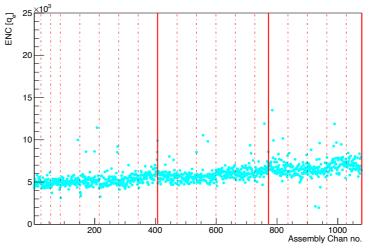
- Micromegas & sTGC Production modules at CERN integrating the VMMs
- All the FE boards are readout through custom made 4.8Gbit serialiser boards with fibres
- Water Cooling is a must in these applications





Noise achieved <2k> ENC on micromegas





Noise achieved <5k> ENC on sTGC





Conclusions

- VMM project was recently concluded successfully for ATLAS New Small Wheels
 - VMM is used for other R&D applications and proposed for several other experiments
- It has been a ~10y project from R&D to production and integration
- It is a state of the art ASIC for physics applications low power, low noise, fully adjustable providing many features and readout techniques
- We have faced many issues along the road:
 - Logic issues on the circuit (reset conflicts, logic conflicts, readout issues with token passing technique)
 - ADCs have been improved significantly but it took two iterations to achieve it
 - Baseline stabilisation issues (design issues and manufacturing problems, still the majority of failures)
- Eventually most of the problems have been addressed and VMMs are already integrated in high density low noise front-end boards on detectors showing the expected performance





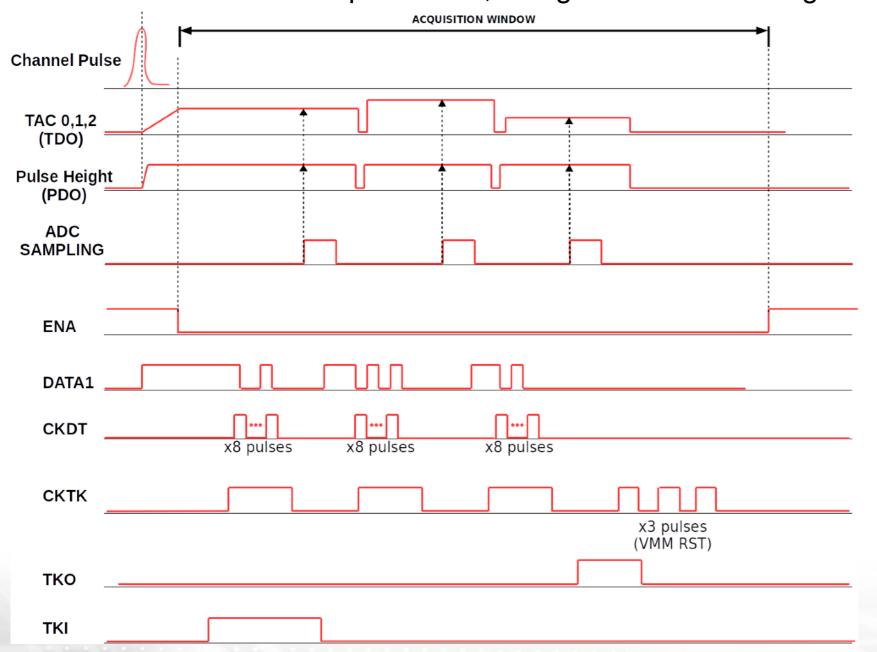
backup





Modes of operation - Analog

In two-phase (analog) mode which is the mode originally implemented in the VMM1, the ASIC operates in two separate phases: **acquisition** and **readout** - During the acquisition phase the events are processed and stored in the **analog memories** of the **peak and time detectors**. As soon as a first event is processed, a flag is raised at the digital output.



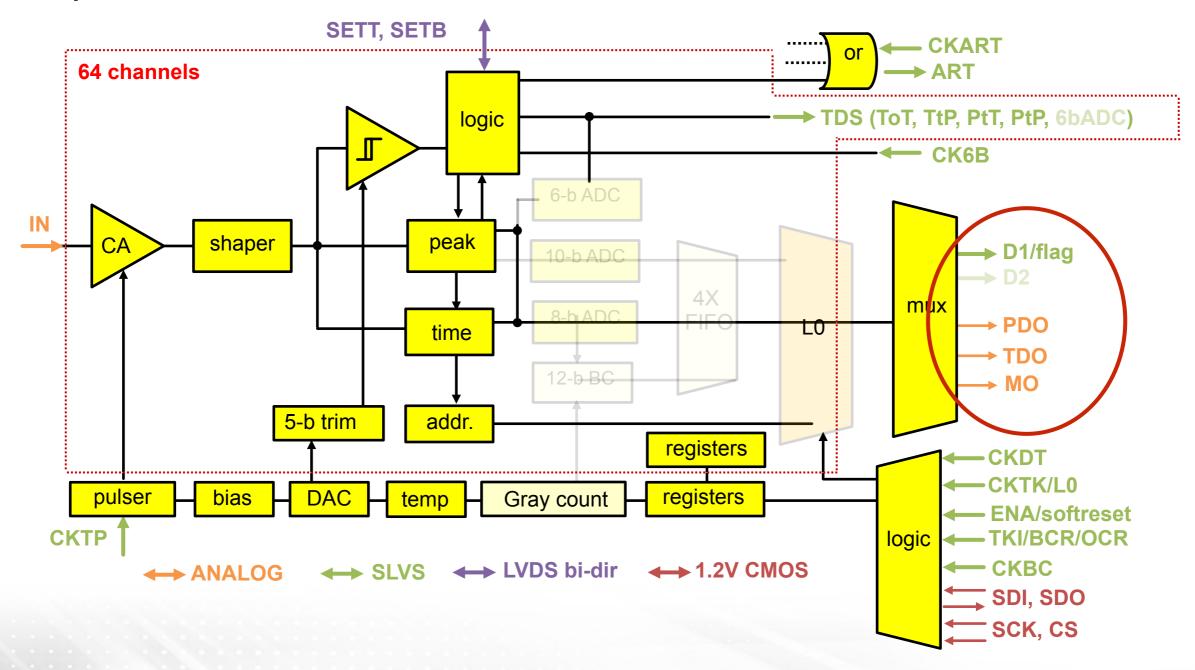
Once the process is complete the ASIC can be switched readout phase.
 The first set of amplitude and time voltages is made available at the analog outputs. The address of the channel is serialised and made available at the digital output using six data clocks.





Modes of operation - Analog

- In this mode all analog buffers are multiplexed in the analog outputs
- Lengthy operation since each analog signal needs to be sampled while the address is read out serially

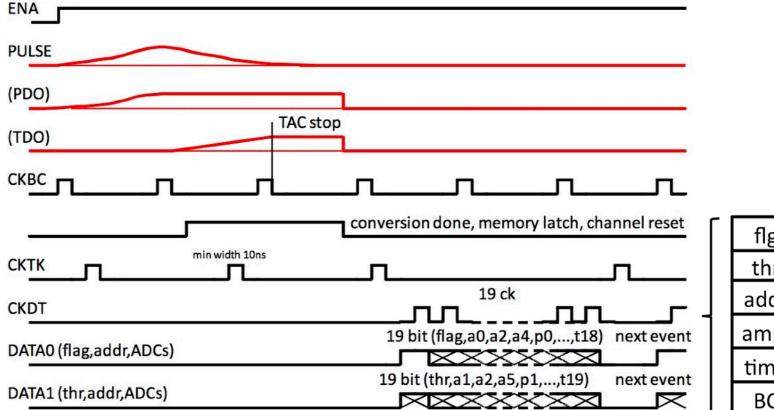


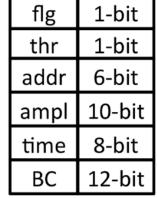




Modes of operation - Continuous

- Trigger-less mode with peak and time detectors convert the voltages into currents routed to the 6/10-bit ADC and 8-bit ADC respectively.
- The 10-bit ADC provides a high resolution A/D conversion of the peak amplitude
- The 8-bit ADC provides the A/D conversion of the timing (measured using the TAC peak or the threshold to a stop signal). Time associated with global 12-bit counter.
- In the continuous mode the **64 channel direct outputs** are available as well providing time-over-threshold (ToT), threshold-to-peak (TtP), peak-to-threshold (PtT), or a 10 ns pulse occurring at peak (PtP) or the 6-bit ADC. The **channel self resets** at the end of the timing pulse, thus providing continuous and **independent operation of all 64-channels.**



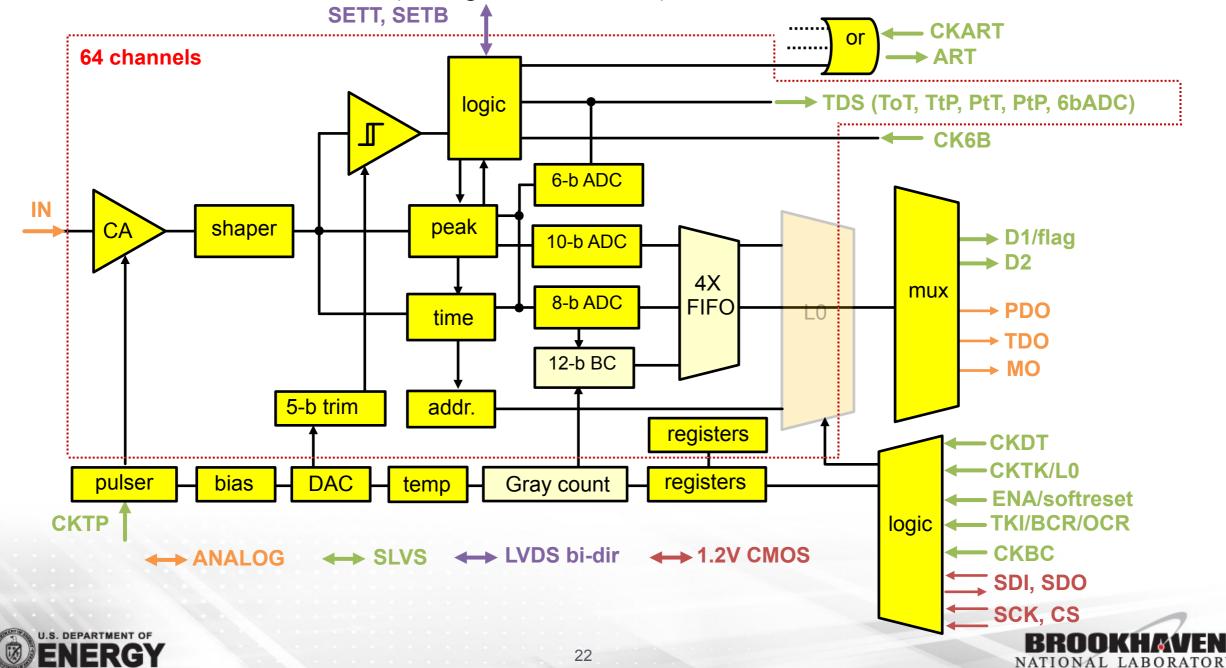






Modes of operation - Continuous

- This mode provides continuous trigger-less readout
- All the outputs and inputs are active and independent
- 6bit ADC conversion within 25ns (configurable + reset)
- 10bit ADC conversion at 200ns (configurable + reset) ← Leading dead-time per channel
- 8bit ADC conversion at 100ns (configurable + reset)

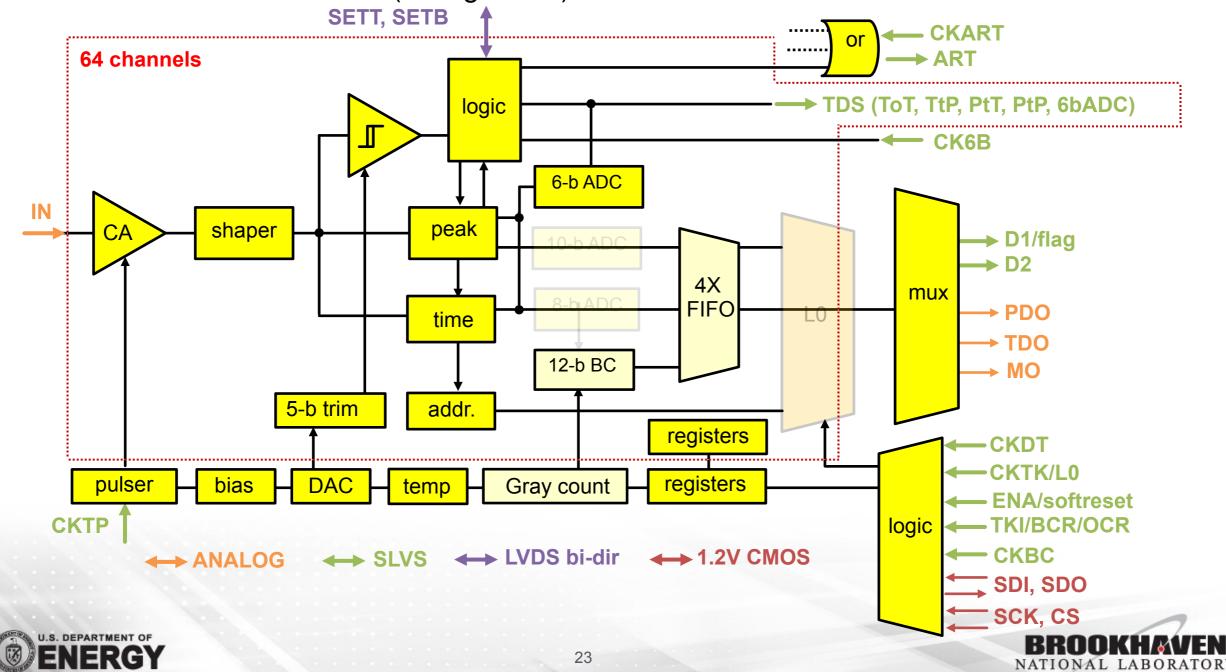


Modes of operation - Direct output

- This mode provides continuous trigger-less readout
- All the outputs and inputs are active and independent
- 6bit ADC conversion within 25ns (configurable)

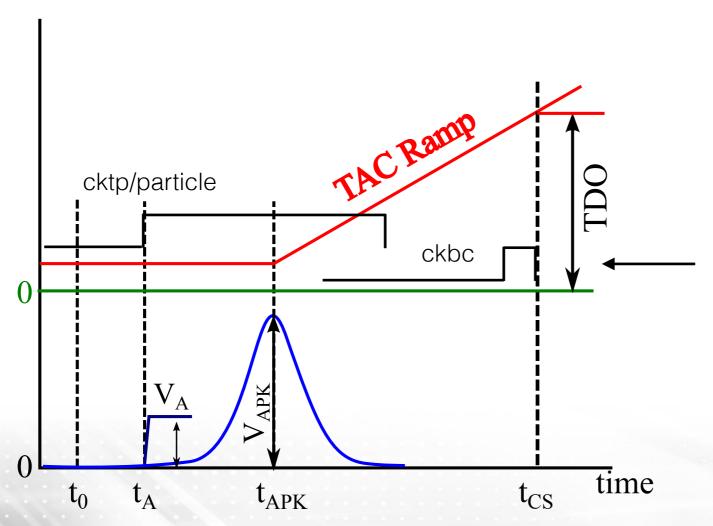
Enabling sfrst, channel resets after 6bit conversion ~ 50ns dead-time

- 8bit ADC conversion at 100ns (configurable)



Modes of operation - Continuous + ext trigger

- VMM design targets synchronous machines hence can be difficult to use in an environment like
 a test beam where asynchronous operation is needed but precise timing is needed to be
 measured (drift time)
- Most chips designed for synchronous machine suffer from time jitter in such environment
- On VMM a mode was foreseen to do such measurement where the ckbc can be used as a strobe and not like a real clock
- It can be send as a trigger signal with a fixed latency achieving precise time measurements



- Trigger signal from external source
- Can be combined with register stcr where channel resets if stop signal not occurs within the TAC ramp
- Implies that trigger is propagated within the TAC ramp up time (60ns-650ns)
- The longer the TAC though the lower the resolution on 8-bit information from the ADC
- Highly correlated trigger readout and noise subtraction



Modes of operation - L0

- The signal processing is done in the same way but the readout is different.
- This is an externally triggered operation for synchronous machines

